



## **Department of Commerce Revises License Review Policy for Semiconductors Exported to China**

January 13, 2026

**WASHINGTON, D.C.** — Today the Department of Commerce’s Bureau of Industry and Security (BIS) issued a rule revising its licensing policy for semiconductor exports to China. BIS will now review export license applications for the Nvidia H200, AMD MI325X, and similar chips on a case-by-case basis provided certain security requirements are met.

Today’s rule follows President Trump’s December 8, 2025 announcement that the United States will allow the H200 and similar products to be shipped to approved customers in China to strengthen national security.

In order to qualify, license applicants must demonstrate that exporting these products to China will not reduce global semiconductor production capacity currently available to U.S. customers; that the Chinese purchaser has adopted export compliance procedures, including customer screening; and that the product has undergone independent, third-party testing in the United States to verify its performance and security.

Under Secretary for Industry and Security Jeffrey Kessler stated: “Export controls should evolve with changes in technology, while protecting national security. Permitting the sale of the H200 to China under controlled conditions will strengthen the American technology ecosystem.”

*The text of the final rule is available on the Federal Register’s website [here](#). The rule is effective immediately upon publication in the Federal Register. Relevant parties can direct questions to Lauren Weber Holley [OCPA@bis.doc.gov](mailto:OCPA@bis.doc.gov).*

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